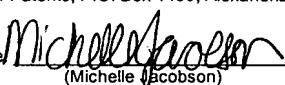




I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service as Express Mail, Label No. EM053196817US, on the date shown below in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: April 30, 2007

Signature: 
(Michelle Jacobson)

Docket No.: 60803(49381)
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Kazuya Fujita et al.

Application No.: 10/773,809

Confirmation No.: 8452

Filed: February 5, 2004

Art Unit: 2814

For: SOLID STATE IMAGING DEVICE,
SEMICONDUCTOR WAFER, OPTICAL
DEVICE MODULE, METHOD OF SOLID
STATE IMAGING DEVICE FABRICATION,
AND METHOD OF OPTICAL DEVICE
MODULE FABRICATION

Examiner: W. S. Louie

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated January 31, 2007, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.